

Electronic Patent Application Fee Transmittal

Application Number:	10773434			
Filing Date:	09-Feb-2004			
Title of Invention:	ELECTROPLATED INTERCONNECTION STRUCTURES ON INTEGRATED CIRCUIT CHIPS			
First Named Inventor/Applicant Name:	Panayotis Constantinou Andricacos			
Filer:	Wenjie Li/Carol Riedinger			
Attorney Docket Number:	YOR91995137X			
Filed as Large Entity				
Utility under 35 USC 111(a) Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Certificate of correction	1811	1	100	100
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100